
2SJ216

Silicon P-Channel MOS FET

HITACHI

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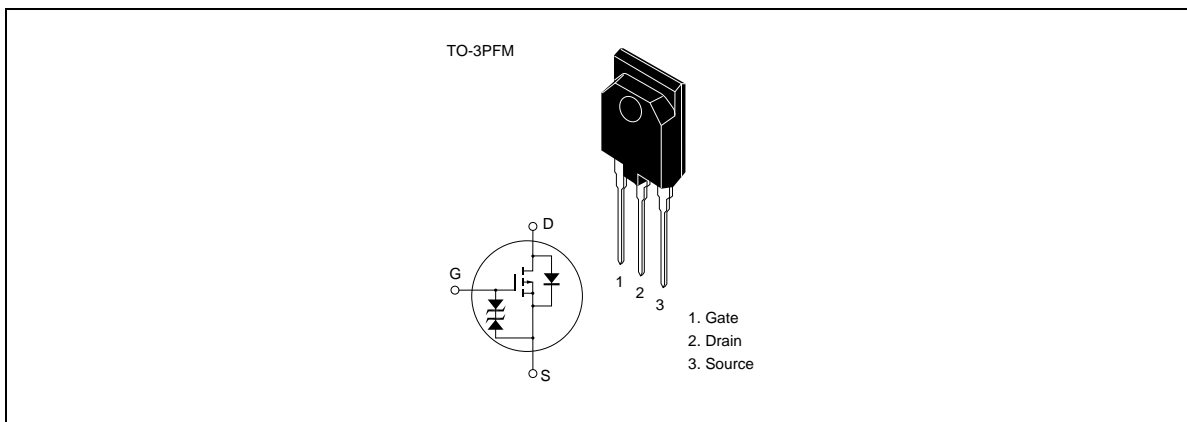
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- 4 V gate drive device
 - _ Can be driven from 5 V source
- Suitable for motor drive, DC-DC converter, power switch and solenoid drive

Outline



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Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	-60	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	-35	A
Drain peak current	I _{D(pulse)} ^{*1}	-140	A
Body to drain diode reverse drain current	I _{DR}	-35	A
Channel dissipation	Pch ^{*2}	50	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

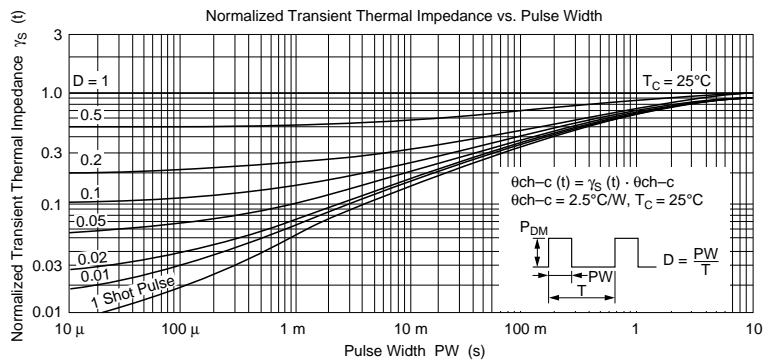
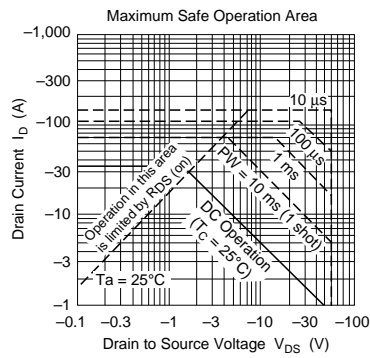
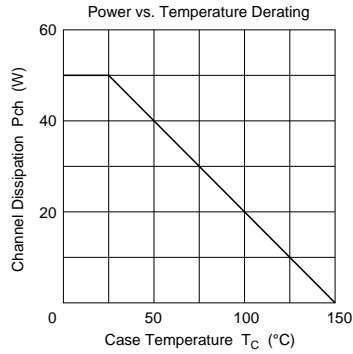
Notes 1. PW ≤ 10 μs, duty cycle ≤ 1%
2. Value at T_c = 25°C

Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	-60	—	—	V	$I_D = -10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	± 20	—	—	V	$I_G = \pm 100 \text{ }\mu\text{A}, V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	± 10	μA	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	-250	μA	$V_{DS} = -50 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	-1.0	—	-2.0	V	$I_D = -1 \text{ mA}, V_{DS} = -10 \text{ V}$
Static drain to source on state resistance	$R_{DS(on)}$	—	0.045	0.06	Ω	$I_D = -18 \text{ A}, V_{GS} = -10 \text{ V}^{*1}$
		—	0.07	0.09		$I_D = -18 \text{ A}, V_{GS} = -4 \text{ V}^{*1}$
Forward transfer admittance	$ y_{fs} $	11	18	—	S	$I_D = -18 \text{ A}, V_{DS} = -10 \text{ V}^{*1}$
Input capacitance	C_{iss}	—	2400	—	pF	$V_{DS} = -10 \text{ V}, V_{GS} = 0,$ $f = 1 \text{ MHz}$
Output capacitance	C_{oss}	—	1300	—	pF	
Reverse transfer capacitance	C_{rss}	—	340	—	pF	
Turn-on delay time	$t_{d(on)}$	—	20	—	ns	$I_D = -15 \text{ A}, V_{GS} = -10 \text{ V},$ $R_L = 2 \text{ }\Omega$
Rise time	t_r	—	175	—	ns	
Turn-off delay time	$t_{d(off)}$	—	460	—	ns	
Fall time	t_f	—	320	—	ns	
Body to drain diode forward voltage	V_{DF}	—	-1.3	—	V	$I_F = -35 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time	t_{rr}	—	250	—	ns	$I_F = -35 \text{ A}, V_{GS} = 0,$ $di_F/dt = 50 \text{ A}/\mu\text{s}$

Note 1. Pulse test

See characteristic curves of 2SJ215



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